

### SEMITRANS<sup>®</sup> 3

### Fast IGBT4 Modules

#### SKM450GB12T4D1

#### Features\*

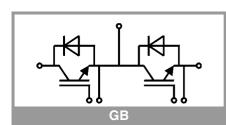
- IGBT4 = 4th generation fast trench IGBT (Infineon)
- CAL4 = Soft switching 4th generation CAL-diode
- Insulated copper baseplate using DBC technology (Direct Bonded Copper)
- Increased power cycling capability
- With integrated gate resistor
- For higher switching frequencies up to 20kHz
- UL recognized, file no. E63532
  SKM...D1: increased diode performance

### **Typical Applications**

- AC inverter drives
- UPS
- Electronic welders at fsw up to 20 kHz

#### Remarks

- Case temperature limited to T<sub>c</sub> = 125°C max.
- Recommended  $T_{op} = -40 \dots +150^{\circ}C$
- Product reliability results valid for T<sub>i</sub> = 150°C



| Absolut             | e Maximum Ratii                                                                | ngs                     |         |       |
|---------------------|--------------------------------------------------------------------------------|-------------------------|---------|-------|
| Symbol              | Conditions                                                                     |                         | Values  | Unit  |
| IGBT                |                                                                                |                         |         |       |
| V <sub>CES</sub>    | T <sub>j</sub> = 25 °C                                                         |                         | 1200    | V     |
| lc                  | T <sub>j</sub> = 175 °C                                                        | T <sub>c</sub> = 25 °C  | 699     | А     |
|                     |                                                                                | T <sub>c</sub> = 80 °C  | 538     | А     |
| I <sub>Cnom</sub>   |                                                                                |                         | 450     | A     |
| I <sub>CRM</sub>    | I <sub>CRM</sub> = 3 x I <sub>Cnom</sub>                                       |                         | 1350    | А     |
| V <sub>GES</sub>    |                                                                                |                         | -20 20  | V     |
| t <sub>psc</sub>    | V <sub>CC</sub> = 800 V<br>V <sub>GE</sub> ≤ 15 V<br>V <sub>CES</sub> ≤ 1200 V | T <sub>j</sub> = 150 °C | 10      | μs    |
| Tj                  |                                                                                |                         | -40 175 | °C    |
| Inverse             | diode                                                                          |                         |         |       |
| V <sub>RRM</sub>    | T <sub>j</sub> = 25 °C                                                         |                         | 1200    | V     |
| I <sub>F</sub>      | T <sub>j</sub> = 175 °C                                                        | T <sub>c</sub> = 25 °C  | 623     | A     |
|                     |                                                                                | T <sub>c</sub> = 80 °C  | 466     | А     |
| I <sub>Fnom</sub>   |                                                                                |                         | 500     | А     |
| I <sub>FRM</sub>    | I <sub>FRM</sub> = 2xI <sub>Fnom</sub>                                         |                         | 1000    | A     |
| I <sub>FSM</sub>    | t <sub>p</sub> = 10 ms, sin 180°, T <sub>j</sub> = 25 °C                       |                         | 2736    | А     |
| Tj                  |                                                                                |                         | -40 175 | °C    |
| Module              |                                                                                |                         |         | · · · |
| I <sub>t(RMS)</sub> |                                                                                |                         | 500     | А     |
| T <sub>stg</sub>    | module without TIM                                                             |                         | -40 125 | °C    |
| V <sub>isol</sub>   | AC sinus 50 Hz, t = 1 min                                                      |                         | 4000    | V     |

| Characte             | eristics                                                                                                                                                                                                                                                                        |                              |      |       |       |     |
|----------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|------------------------------|------|-------|-------|-----|
| Symbol               | Conditions                                                                                                                                                                                                                                                                      | min.                         | typ. | max.  | Unit  |     |
| IGBT                 |                                                                                                                                                                                                                                                                                 |                              |      |       |       |     |
| V <sub>CE(sat)</sub> | I <sub>C</sub> = 450 A                                                                                                                                                                                                                                                          | T <sub>j</sub> = 25 °C       |      | 1.84  | 2.07  | V   |
|                      | V <sub>GE</sub> = 15 V<br>chiplevel                                                                                                                                                                                                                                             | T <sub>j</sub> = 150 °C      |      | 2.23  | 2.42  | V   |
| V <sub>CE0</sub>     | chiplevel                                                                                                                                                                                                                                                                       | T <sub>j</sub> = 25 °C       |      | 0.80  | 0.90  | V   |
|                      |                                                                                                                                                                                                                                                                                 | T <sub>j</sub> = 150 °C      |      | 0.70  | 0.80  | V   |
| r <sub>CE</sub>      | V <sub>GE</sub> = 15 V                                                                                                                                                                                                                                                          | T <sub>j</sub> = 25 °C       |      | 2.3   | 2.6   | mΩ  |
|                      | chiplevel                                                                                                                                                                                                                                                                       | T <sub>j</sub> = 150 °C      |      | 3.4   | 3.6   | mΩ  |
| $V_{\text{GE(th)}}$  | $V_{GE}=V_{CE}$ , $I_C = 16.4$ mA                                                                                                                                                                                                                                               |                              | 5.3  | 5.8   | 6.3   | V   |
| I <sub>CES</sub>     | $V_{GE} = 0 V, V_{CE} = 12$                                                                                                                                                                                                                                                     | 00 V, T <sub>j</sub> = 25 °C |      |       | 5     | mA  |
| C <sub>ies</sub>     |                                                                                                                                                                                                                                                                                 | f = 1 MHz                    |      | 27.2  |       | nF  |
| Coes                 | V <sub>CE</sub> = 25 V<br>V <sub>GE</sub> = 0 V                                                                                                                                                                                                                                 | f = 1 MHz                    |      | 1.76  |       | nF  |
| C <sub>res</sub>     |                                                                                                                                                                                                                                                                                 | f = 1 MHz                    |      | 1.50  |       | nF  |
| $Q_{G}$              | V <sub>GE</sub> = - 8 V+ 15 V                                                                                                                                                                                                                                                   |                              |      | 2500  |       | nC  |
| R <sub>Gint</sub>    | T <sub>j</sub> = 25 °C                                                                                                                                                                                                                                                          |                              |      | 1.9   |       | Ω   |
| t <sub>d(on)</sub>   | $\begin{array}{l} I_{C} = 450 \text{ A} \\ V_{GE} = +15/\text{-}15 \text{ V} \\ R_{G \text{ on}} = 1 \ \Omega \\ R_{G \text{ off}} = 1 \ \Omega \\ \text{di/dt}_{\text{on}} = 8300 \text{ A/}\mu\text{s} \\ \text{di/dt}_{\text{off}} = 3800 \text{ A/}\mu\text{s} \end{array}$ | T <sub>j</sub> = 150 °C      |      | 248   |       | ns  |
| t <sub>r</sub>       |                                                                                                                                                                                                                                                                                 | T <sub>j</sub> = 150 °C      |      | 59    |       | ns  |
| Eon                  |                                                                                                                                                                                                                                                                                 | T <sub>j</sub> = 150 °C      |      | 28    |       | mJ  |
| t <sub>d(off)</sub>  |                                                                                                                                                                                                                                                                                 | T <sub>j</sub> = 150 °C      |      | 492   |       | ns  |
| t <sub>f</sub>       |                                                                                                                                                                                                                                                                                 | T <sub>j</sub> = 150 °C      |      | 100   |       | ns  |
| E <sub>off</sub>     |                                                                                                                                                                                                                                                                                 | T <sub>j</sub> = 150 °C      |      | 48    |       | mJ  |
| R <sub>th(j-c)</sub> | per IGBT                                                                                                                                                                                                                                                                        |                              |      |       | 0.062 | K/W |
| R <sub>th(c-s)</sub> | per IGBT (λ <sub>grease</sub> =0.81 W/(m*K))                                                                                                                                                                                                                                    |                              |      | 0.028 |       | K/W |
| R <sub>th(c-s)</sub> | per IGBT, pre-applied phase change material                                                                                                                                                                                                                                     |                              |      | 0.017 |       | K/W |



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#### **Typical Applications**

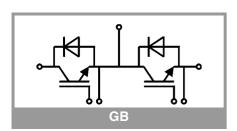
#### AC inverter drives

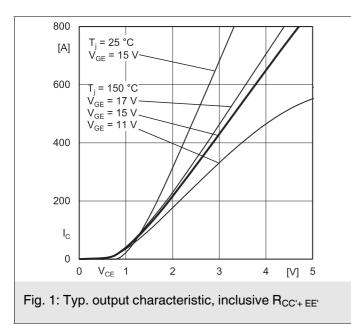
- UPS
- Electronic welders at fsw up to 20 kHz

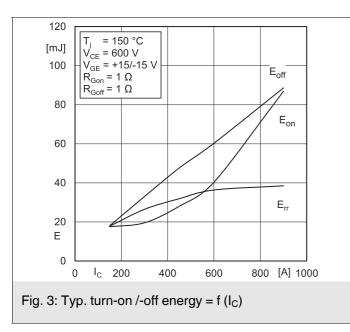
#### Remarks

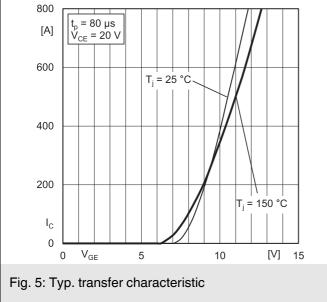
- Case temperature limited
- to  $T_c = 125^{\circ}C$  max. • Recommended  $T_{op} = -40 \dots +150^{\circ}C$
- Recommended Top = -40 ... +150 C
  Product reliability results valid
- for  $T_j = 150^{\circ}C$

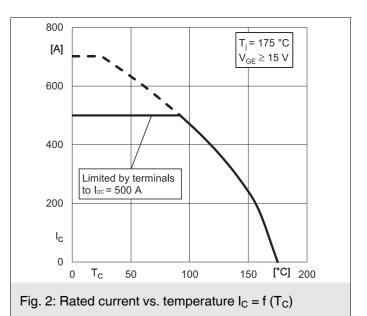
| Characte              | ristics                                                                                    |                         |      |       |      |     |
|-----------------------|--------------------------------------------------------------------------------------------|-------------------------|------|-------|------|-----|
| Symbol                | Conditions                                                                                 | min.                    | typ. | max.  | Unit |     |
| Inverse d             | iode                                                                                       |                         |      |       |      |     |
| $V_F = V_{EC}$        | $I_F = 450 \text{ A}$<br>$V_{GE} = 0 \text{ V}$<br>chiplevel                               | T <sub>j</sub> = 25 °C  |      | 2.04  | 2.35 | V   |
|                       |                                                                                            | T <sub>j</sub> = 150 °C |      | 1.94  | 2.23 | V   |
| V <sub>F0</sub>       | chiplevel                                                                                  | T <sub>j</sub> = 25 °C  |      | 1.30  | 1.50 | V   |
|                       |                                                                                            | T <sub>j</sub> = 150 °C |      | 0.90  | 1.10 | V   |
| r <sub>F</sub>        | chiplevel                                                                                  | T <sub>j</sub> = 25 °C  |      | 1.64  | 1.88 | mΩ  |
|                       |                                                                                            | T <sub>j</sub> = 150 °C |      | 2.3   | 2.5  | mΩ  |
| I <sub>RRM</sub>      | I <sub>F</sub> = 450 A                                                                     | T <sub>j</sub> = 150 °C |      | 498   |      | Α   |
| Q <sub>rr</sub>       | di/dt <sub>off</sub> = 7900 A/μs<br>V <sub>GE</sub> = -15 V                                | T <sub>j</sub> = 150 °C |      | 79    |      | μC  |
| E <sub>rr</sub>       | $V_{GE} = -13$ V<br>V <sub>CC</sub> = 600 V                                                | T <sub>j</sub> = 150 °C |      | 32    |      | mJ  |
| R <sub>th(j-c)</sub>  | per diode                                                                                  |                         |      | 0.095 | K/W  |     |
| R <sub>th(c-s)</sub>  | per diode ( $\lambda_{grease}$ =0.81 W/(m*K))                                              |                         |      | 0.037 |      | K/W |
| R <sub>th(c-s)</sub>  | per diode, pre-applied phase change material                                               |                         |      | 0.03  |      | K/W |
| Module                |                                                                                            |                         |      |       |      |     |
| L <sub>CE</sub>       |                                                                                            |                         |      | 15    |      | nH  |
| R <sub>CC'+EE'</sub>  | measured per<br>switch                                                                     | T <sub>C</sub> = 25 °C  |      | 0.55  |      | mΩ  |
|                       |                                                                                            | T <sub>C</sub> = 125 °C |      | 0.85  |      | mΩ  |
| R <sub>th(c-s)1</sub> | calculated without thermal coupling                                                        |                         |      | 0.008 |      | K/W |
| R <sub>th(c-s)2</sub> | including thermal coupling,<br>Ts underneath module<br>(λ <sub>grease</sub> =0.81 W/(m*K)) |                         |      | 0.013 |      | K/W |
| R <sub>th(c-s)2</sub> | including thermal coupling,<br>Ts underneath module, pre-applied<br>phase change material  |                         |      | 0.009 |      | K/W |
| Ms                    | to heat sink M6                                                                            |                         | 3    |       | 5    | Nm  |
| Mt                    |                                                                                            | to terminals M6         | 2.5  |       | 5    | Nm  |
|                       | 1                                                                                          |                         |      |       |      | Nm  |
| w                     |                                                                                            |                         |      |       | 325  | g   |

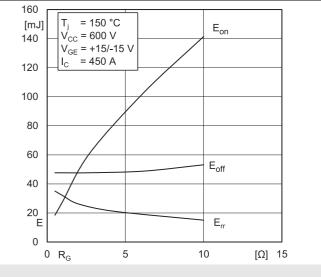


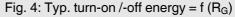


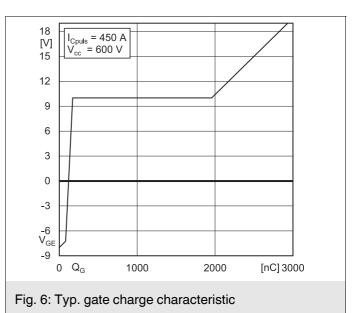


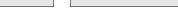


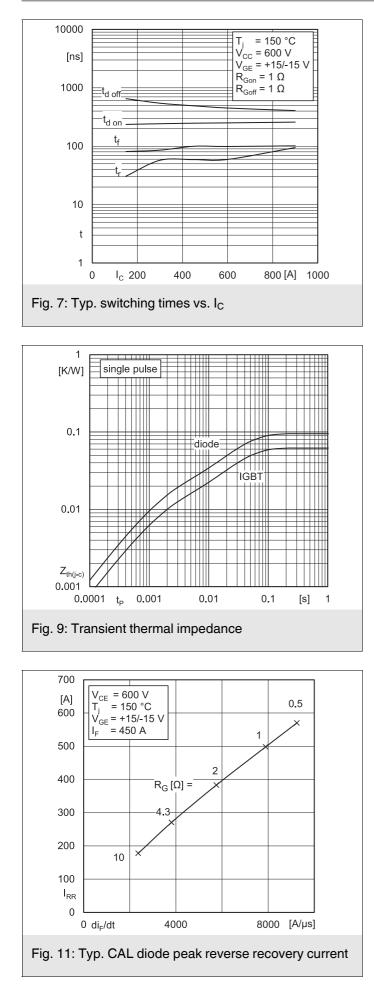












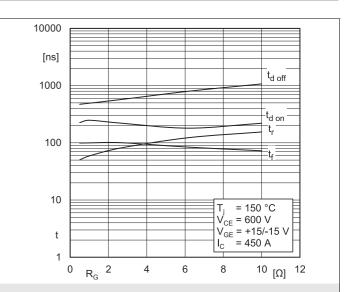
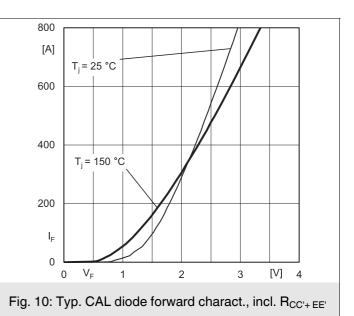
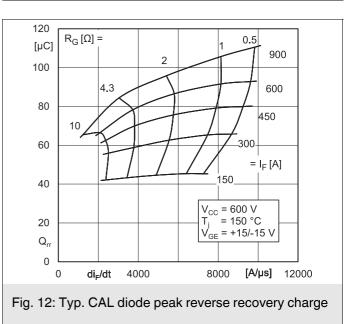
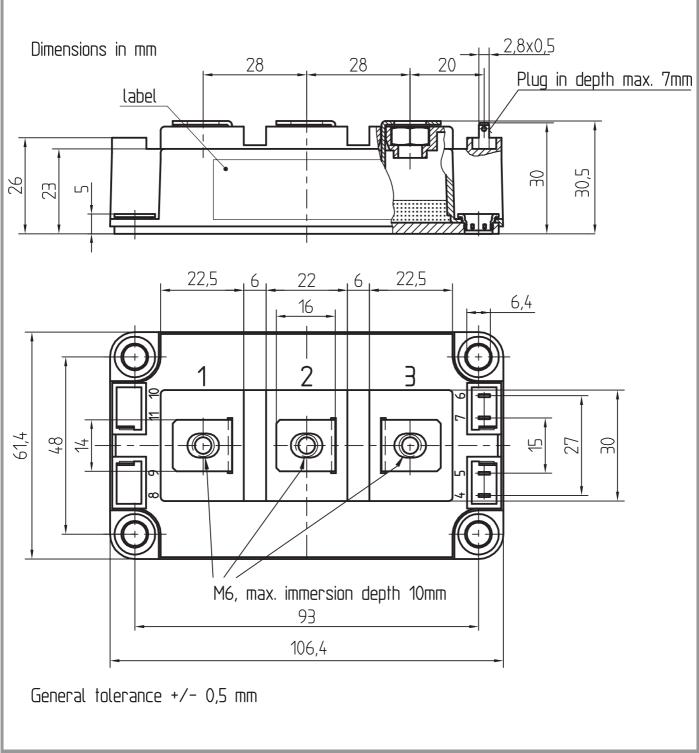


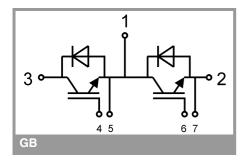
Fig. 8: Typ. switching times vs. gate resistor R<sub>G</sub>











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This is an electrostatic discharge sensitive device (ESDS), international standard IEC 60747-1, chapter IX.

#### **\*IMPORTANT INFORMATION AND WARNINGS**

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